



Contents lists available at ScienceDirect

## Nuclear Inst. and Methods in Physics Research, A

journal homepage: [www.elsevier.com/locate/nima](http://www.elsevier.com/locate/nima)



# Characterization and simulation of radiation effects on active edges n-on-p technology planar pixel sensors

Djemouai Djamai<sup>a,\*</sup>, Khaoula Aouadj<sup>b</sup>, Slimane Oussalah<sup>c</sup>, Abdenour Lounis<sup>d</sup>, Evangelos-Leonidas Gkoukousis<sup>e</sup>

<sup>a</sup> Laboratory of Engineering and Sciences of Advanced Materials (ISMA), Abbes Laghrour-Khenchela University, Algeria

<sup>b</sup> Laboratory for the Physical and Chemical Study of Materials (LEPCM), Batna 1 University, Algeria

<sup>c</sup> Centre de Développement des Technologies Avancées (CDTA), Algiers, Algeria

<sup>d</sup> Laboratoire de Physique des 2 Infinis Irène Joliot-Curie (IJCLab), Université Paris-Saclay, France

<sup>e</sup> University of Zurich Physics Institute, Zürich, Switzerland

## ARTICLE INFO

### Keywords:

HL-LHC  
Active edge  
Radiation damage

## ABSTRACT

The ATLAS inner tracker has to be upgraded to meet the requirements for radiation hardness and geometrical acceptance in order to withstand the harsh conditions of High Luminosity LHC (HL-LHC). This requires segmented silicon sensors of increased geometrical efficiency. The active edge technology allows to reduce the inactive area at the border of the sensor. The main objective of this work is to evaluate by TCAD simulation, conducted using Silvaco™ TCAD software, the performance of planar n-on-p technology sensors with active edges exposed to high level of radiation for fluences up to  $1 \times 10^{16} \text{ n}_{eq}/\text{cm}^2$ , using a three-level trap model for ptype FZ silicon material. By using the secondary ion mass spectrometry (SIMS) technique, an accurate representation of the sensor structure was obtained in terms of doping concentration profile. Charge collection efficiency (CCE) is studied as a function of radiation fluence.